

Assembly Notes:

- 1) Built using PMP6961 Rev E PCB.
- 2) Added from PMP6961 Rev E to PMP7453 Rev B: D100.



Note: C4 is not needed if PFC bulk cap is present

220VDC-400VDC Input

28V/3.6A Output

PCB LOGO
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Designed for:	Mod. Date:	3/25/2014
Project Title:	220-400VDCin, 28V/100W Active Clamp Forward	
Sheet Title:		
Number: PMP7453	Rev: B	
SVN Rev: Not in version control	Assembly Variant: 001	Sheet: 1 of 1
Drawn By:	File: PMP7453_REV.B_SchDoc	Size: B
Engineer: B King	Contact: http://www.ti.com/support	



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